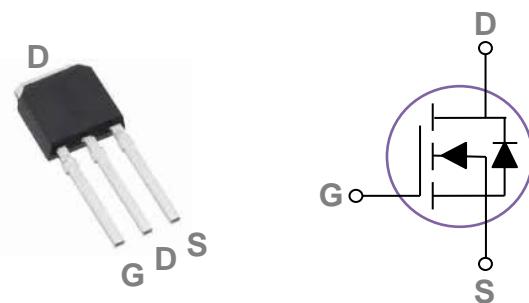


General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

TO251 Pin Configuration



BVDSS	RDS(ON)	ID
115V	13.5mΩ	55A

Features

- 115V, 55A, RDS(ON) = 13.5mΩ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	115	V
V _{Gs}	Gate-Source Voltage	+20 / -12	V
I _D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	55	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	35	A
I _{DM}	Drain Current – Pulsed ¹	220	A
EAS	Single Pulse Avalanche Energy ²	151	mJ
I _{AS}	Single Pulse Avalanche Current ²	55	A
P _D	Power Dissipation ($T_c=25^\circ\text{C}$)	105	W
	Power Dissipation – Derate above 25°C	0.84	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	1.15	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	115	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V , V _{GS} =0V , T _J =25°C	---	---	1	uA
		V _{DS} =80V , V _{GS} =0V , T _J =85°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =20V , V _{DS} =0V	---	---	100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance ³	V _{GS} =10V , I _D =15A	---	11	13.5	mΩ
		V _{GS} =4.5V , I _D =8A	---	15	20	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.2	1.8	2.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _D =3A	---	14	---	S

Dynamic and switching Characteristics

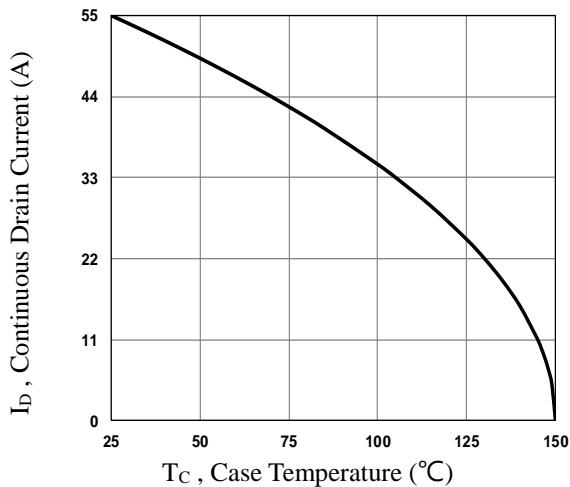
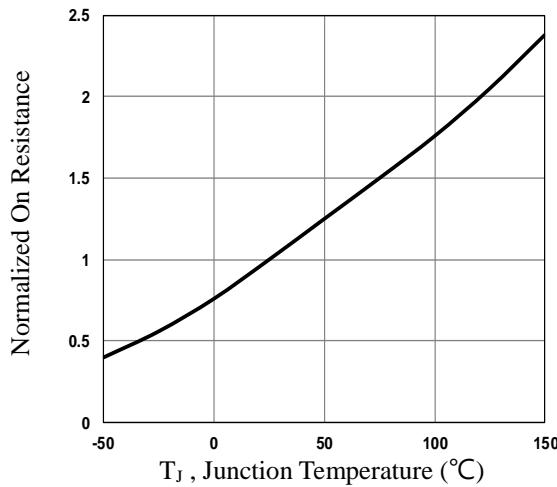
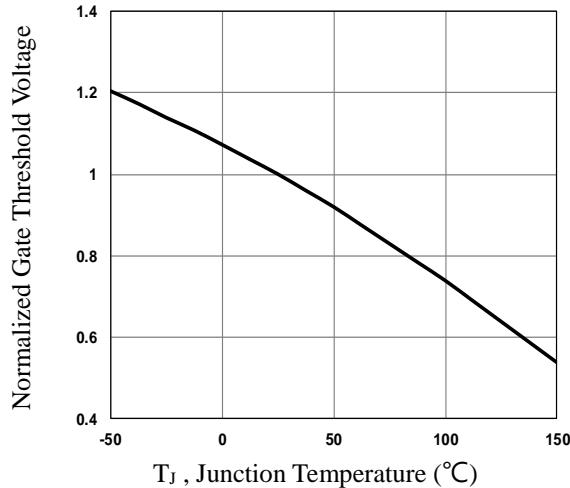
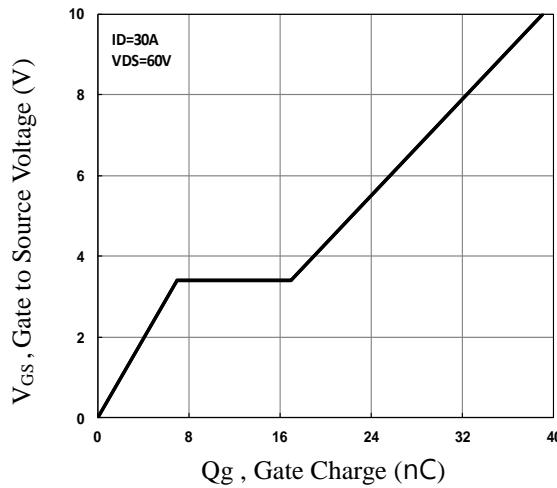
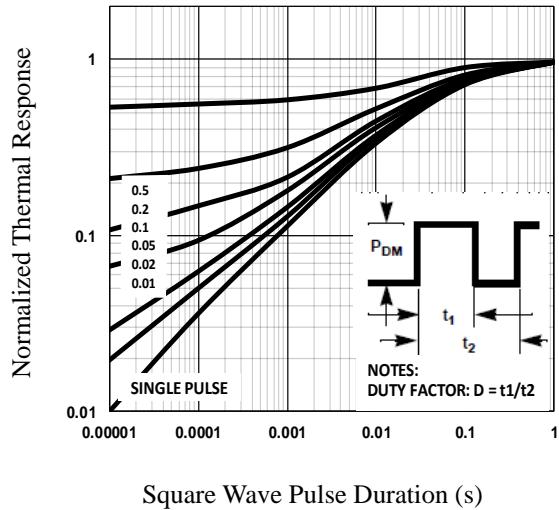
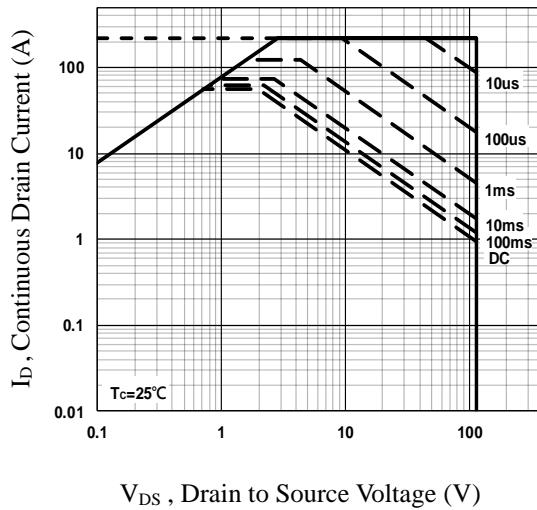
Q _g	Total Gate Charge ^{3, 4}	V _{DS} =60V , V _{GS} =10V , I _D =30A	---	39	60	nC
Q _{gs}	Gate-Source Charge ^{3, 4}		---	7	10	
Q _{gd}	Gate-Drain Charge ^{3, 4}		---	10	15	
T _{d(on)}	Turn-On Delay Time ^{3, 4}	V _{DD} =60V , V _{GS} =10V , R _G =6Ω I _D =30A	---	15	25	ns
T _r	Rise Time ^{3, 4}		---	22	35	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}		---	54	80	
T _f	Fall Time ^{3, 4}		---	85	130	
C _{iss}	Input Capacitance	V _{DS} =60V , V _{GS} =0V , F=1MHz	---	2560	3840	pF
C _{oss}	Output Capacitance		---	220	330	
C _{rss}	Reverse Transfer Capacitance		---	5	10	
R _g	Gate Resistance	V _{GS} =0V , V _{DS} =0V , F=1MHz	---	1.4	---	Ω

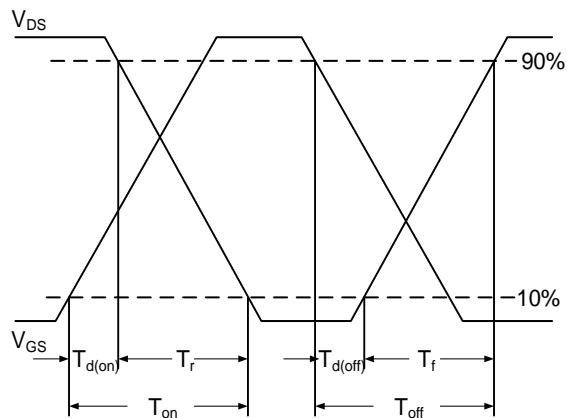
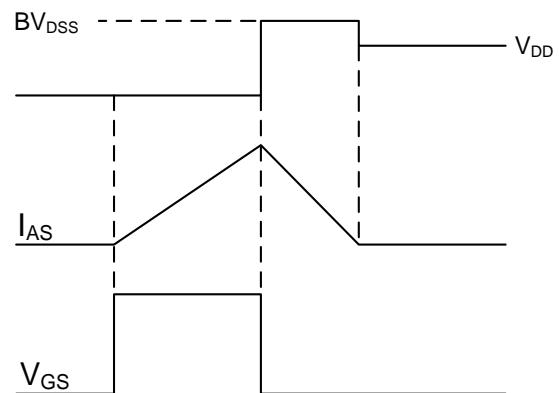
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _s	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	55	A
I _{SM}	Pulsed Source Current		---	---	110	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _s =1A , T _J =25°C	---	---	1	V
t _{rr}	Reverse Recovery Time ³	V _R =100V, I _s =10A dI/dt=100A/μs , T _J =25°C	---	50	---	ns
Q _{rr}	Reverse Recovery Charge ³		---	100	---	nC

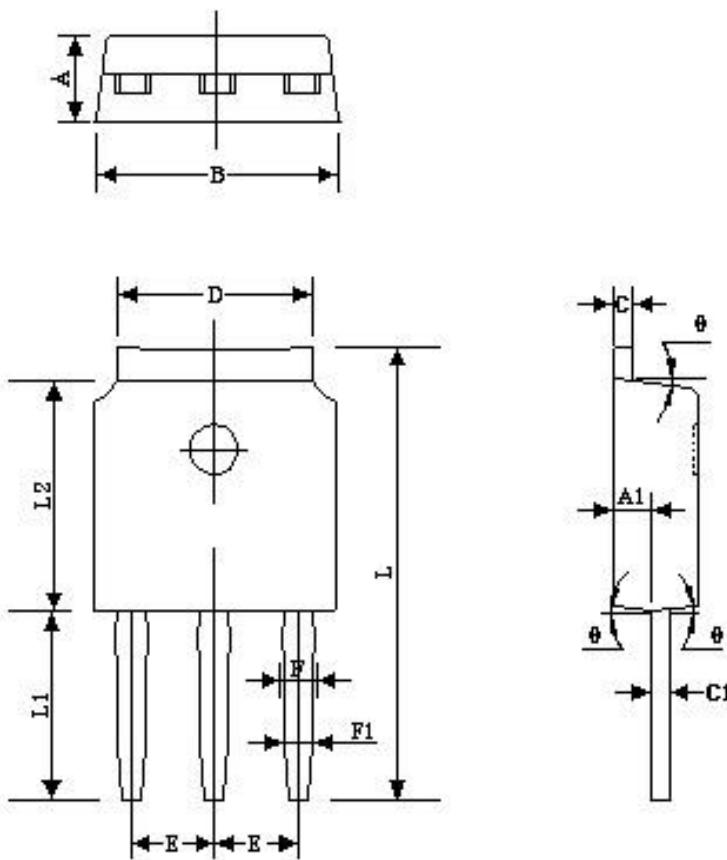
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=50V,V_{GS}=10V,L=0.1mH,I_{AS}=55A.,R_G=25Ω,Starting T_J=25°C.
3. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
4. Essentially independent of operating temperature.


Fig.1 Continuous Drain Current vs. T_c

Fig.2 Normalized RD_{SON} vs. T_J

Fig.3 Normalized V_{th} vs. T_J

Fig.4 Gate Charge Waveform

Fig.5 Normalized Transient Impedance

Fig.6 Maximum Safe Operation Area


Fig.7 Switching Time Waveform

Fig.8 EAS Waveform

TO251 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.500	2.100	0.098	0.083
A1	1.250	0.900	0.049	0.035
B	6.800	6.400	0.268	0.252
C	0.580	0.420	0.023	0.017
C1	0.580	0.420	0.023	0.017
D	5.500	5.000	0.217	0.197
E	2.400	2.000	0.094	0.079
F	1.050	0.750	0.041	0.030
F1	0.900	0.650	0.035	0.026
L	12.400	11.600	0.488	0.457
L1	5.300	4.700	0.209	0.185
L2	6.300	5.700	0.248	0.224
θ	9°	3°	9°	3°